

SUGGESTED P.C.B LAYOUTS6

HBS-V152XS30-xxx  
S30:SEMIGOLD30u"

**1.MATERIALS AND FINISH**  
**1.1 HOUSING MATERIALS:**  
 THERMOPLASTIC(UL 94V-0). BLACK.  
**1.2 CONTACTS:**  
 COPPER ALLOY  
**1.3 PLATING:**  
 GOLD 30u" PLATING ON CONTACT AREA.  
 TIN/LEAD PLATING ON SOLDER TAIL.  
 UNDER PLATING NICKEL.

**2.SPECIFICATIONS**  
**2.1 CURRENT RATING:**  
 1 A MAX.  
**2.2 INSULATION RESISTANCE:**  
 5000 MΩ MIN AT 500V DC.  
**2.3 DIELECTRIC WITHSTANDING VOLTAGE:**  
 600V (r.m.s) AC FOR 1 MINUTE.  
**2.4 OPERATING TEMPERATURE:**  
 -40°C ~ +85°C.

Number Of Position	DIMENSIONS	
	A	B
20	20.70	19.10
26	24.51	22.91
30	27.05	25.45
34	29.59	27.99
36	30.86	29.26
40	33.40	31.80
50	39.75	38.15
60	46.10	44.50
68	51.18	49.58
80	58.80	57.20
100	71.50	69.90



PART NO. HBS-V152X-xxx

DWG NO. HBS-V152X-xxx

FILE NO.

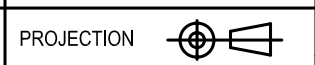
UNIT / mm

APPROVED BY CY

DRAWING BY

SCALE 1:1

PROJECTION



TOLERANCES ARE  
 .X ±0.30  
 .XX ±0.20  
 .XXX  
 AWG

DESCRIPTION:

BOX HEADER DIP 1.27X2.54mm  
 REVISIONS HK DATE

煜倫股份有限公司